Technical Data Data Sheet 3119, Rev. -

30BQ040 SCHOTTKY RECTIFIER

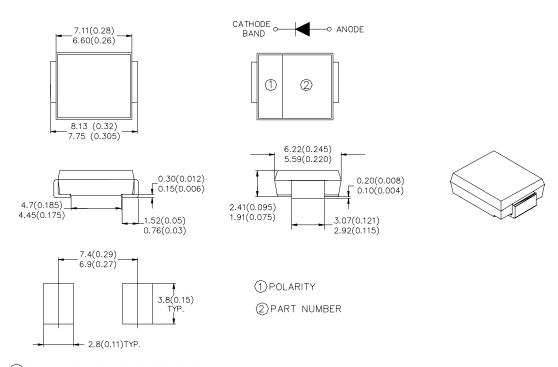
Applications:

- Switching power supply Converters Free-Wheeling diodes Reverse battery protection
- Disk drives Battery charging

Features:

- Small foot print, surface mountable
- Very low forward voltage drop
- High frequency operation
- . Guard ring for enhanced ruggedness and long term reliability

Mechanical Dimensions: In Inches / mm



3 RECOMMENDED FOOT PRINT FOR SOLDER AREA ON PC BOARD

SMC



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Maximum Ratings:

Characteristics	Symbol	Condition	Max.	Units
Peak Inverse Voltage	V_{RWM}	-	40	V
Max. Average Forward	I _{F(AV)}	50% duty cycle @T _L = 118°C,	3.0	
Current		rectangular wave form		Α
		50% duty cycle @T _L =110°C, rectangular wave form	4.0	^
Max. Peak One Cycle Non- Repetitive Surge Current	I _{FSM}	8.3 ms, half Sine pulse	132	А
Non-Repetitive Avalanche Energy	E _{AS}	T _J = 25 °C, I _{AS} = 0.6A, L = 6.6 mH	35	mJ
Repetitive Avalanche Current	I _{AR}	Current decaying linearly to zero in 1 µsec Frequency limited by T _J max. V _A = 1.5 x V _R typical	0.6	А

Electrical Characteristics:

Characteristics	Symbol	Condition	Max.	Units
Max. Forward Voltage Drop *	V_{F1}	@ 3 A, Pulse, T _J = 25 °C	0.53	V
		@ 6 A, Pulse, T _J = 25 °C	0.68	
	V_{F2}	@ 3 A, Pulse, T _J = 125 °C	0.43	V
		@ 6 A, Pulse, T _J = 125 °C	0.57	
Max. Reverse Current *	I _{R1}	@V _R = rated V _R	0.5	mA
		T _J = 25 °C		
	I_{R2}	@V _R = rated V _R	30	mA
		T _J = 125 °C		
Max. Junction Capacitance	C_T	$@V_R = 5 \text{ V}, T_C = 25 ^{\circ}\text{C}$	230	pF
		f _{SIG} = 1MHz		
Typical Series Inductance	L_S	Measured lead to lead 5 mm	3.0	nH
		from package body		
Max. Voltage Rate of	dv/dt	-	10,000	V/μs
Change				

^{*} Pulse Width < 300µs, Duty Cycle <2%

Thermal-Mechanical Specifications:

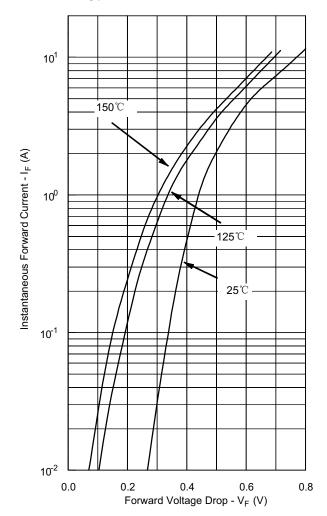
Characteristics	Symbol	Condition	Specification	Units
Max. Junction Temperature	T_J	-	-55 to +150	Ô
Max. Storage Temperature	T _{stg}	-	-55 to +150	°C
Max. Thermal Resistance, Junction to Lead	$R_{ heta JL}$	DC operation	12	°C/W
Max. Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	DC operation	46	°C/W
Approximate Weight	wt	-	0.24	g
Case Style	SMC			

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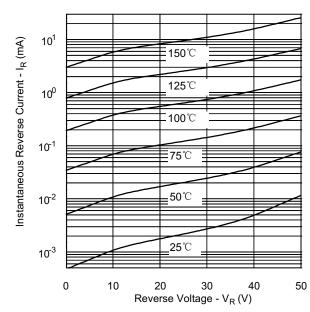
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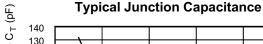
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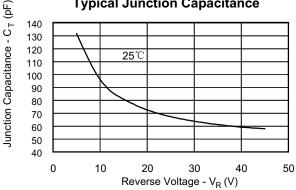
Typical Forward Characteristics



Typical Reverse Characteristics







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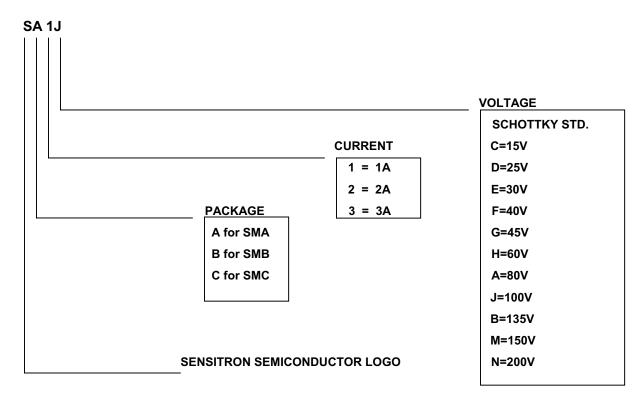
Marking & Identification

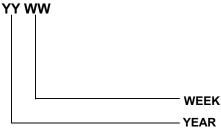
Each device has 2 rows of marking for identification.

The first row designates the device as manufactured by Sensitron Semiconductor as indicated by the letter "S". It also contains the information about package style, current and voltage rating.

The second row indicates the year and the week of manufacturing.







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TECHNICAL DATA

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